Express Mail Label No. EV643737749US Docket No.: NEK-0011 COVER SHEET F_RM PTO-1595 (Modified) U.S. DEPARTMENT OF COMMERCE (Kev. 03-01) 55 1 Kate and Trademark Office 05-22-2006 OMB No. 0651-0027 (exp.5/31/2002) P08A/REV03 Tab settings → → cord the attached original documents or copy thereof. To the Director of the United St 103242388 and address of receiving party(ies): 1. Name of conveying party(ies): Jae-Hyug CHA, Seung-Hun CHAE, Seong-Lyong KIM, Name: LG CHEM, LTD. Jun-Tae LEE and Byung-Tae YANG Address: LG Twin Tower, East Tower 20 Yeouido-dong, Yeongdeungpo-gu ☐ Yes ☒ No Additional names(s) of conveying party(ies) 3. Nature of conveyance: ☐ Merger City: Seoul ☐ Security Agreement ☐ Change of Name _____ State/Prov.: Country: KOREA Other Execution Date: 9-22, 20, 21, 22, 20-2005 ☐ Yes X No Additional name(s) & address(es) 4. Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: 9-22, 23, 21, 22, 20-05 Patent Application No. B. Patent No.(s) Filing date Additional numbers 6. Total number of applications and patents involved: 5. Name and address of party to whom correspondence concerning document should be mailed: Name: Soonja Bae 7. Total fee (37 CFR 3.41):....\$ 40.00 Limited Recognition No. L0017 ☐ Enclosed - Any excess or insufficiency should be Registration No. credited or debited to deposit account Address: Cantor Colburn LLP Authorized to be charged to deposit account 55 Griffin Road South 8. Deposit account number:

Country: USA ZIP: 06002 (Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Soonja Bae

November 2, 2005

Name of Person Signing

Noter 1 Date

State/Prov.: CT

City: Bloomfield

06-1130

Total number of pages including cover sheet, attachments, and document:

ASSIGNMENT

WHEREAS We, CHA, Jae-Hyug of 104-1 Munji-dong, Yuseong-gu, Daejeon 305-380 Republic of Korea; CHAE, Seung-Hun of Gyeongseong Keunmaeul Apt. 105-1109 Galma 2-dong, Seo-gu, Daejeon 302-756 Republic of Korea; KIM, Seong-Lyong of Expo Apt. 405-402, Jeonmin-dong, Yuseong-gu, Daejeon 305-762 Republic of Korea; LEE, Jun-Tae of 1025-24 Suseong 4-ga, Suseong-gu, Daegu 706-836 Republic of Korea; YANG, Byung-Tae of LG Dowon sataek 2-707, 435, Ansan-dong, Yeosu-si 555-050 Republic of Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

THERMOPLASTIC RESIN COMPOSITION

which claims priority to Korean Application No. 10-2003-0028214 filed on May 02, 2003, Korean Application No. 10-2003-0034350 filed on May 29, 2003, Korean Application No. 10-2003-0079499 filed on November 11, 2003, Korean Application No. 10-2004-0010900 filed on February 19, 2004 and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, LG CHEM, LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea, having a place of business at LG CHEM, LTD. LG Twin Tower, East Tower 20, Yeouido-dong, Yeongdeungpo-gu, Seoul 150-721, Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application;

and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

		(
Date:	Sep/22/05	CHA, Jac-Hyug	L.S
Date:	9/20/05	Zu Tolls	L.S
Date:	9/21/ot	CHAE, Seung-Hun Kim Seong Lyong KIM, Seong-Lyong	L.S
Date:	9/22/05	LEE, Juntae Cee	L.S
Date:	9/20/05	YANG, Byung-Tae	L.S

RECORDED: 11/02/2005